



## HBN25T120-SADCH

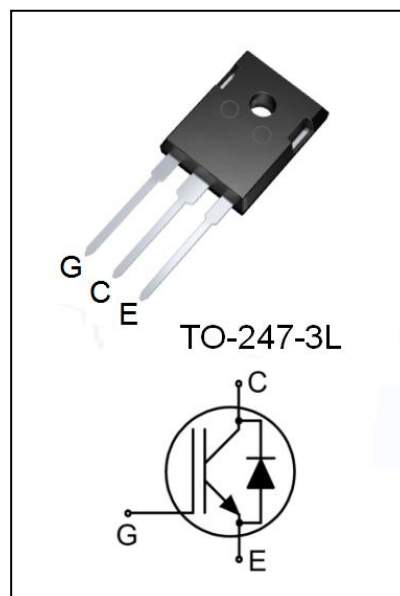
1200V N-Channel Insulated Gate Bipolar Transistor

### ● Features:

- 25.0A, 1200V,  $V_{CESAT(Typ)} = 2.1V @ V_{GE}=15V, I_C=25A$
- Trench FS Technology
- With Fast Recovery anti-parallel Diode
- Low Gate Charge
- Low Saturation Voltage
- Low Switching Loss
- Positive Temperature Coefficient

### ● Application:

- General Purpose Inverters
- Welding Machine
- UPS



### Absolute Maximum Ratings( $T_C=25^{\circ}C$ unless otherwise noted)

| Symbol    | Parameter                                                                           | Value       | Unit        |
|-----------|-------------------------------------------------------------------------------------|-------------|-------------|
| $V_{CE}$  | Collector-Emitter Voltage                                                           | 1200        | V           |
| $I_C$     | Collector Current-Continuous<br>- ( $T_C=25^{\circ}C$ )<br>- ( $T_C=100^{\circ}C$ ) | 50          | A           |
|           |                                                                                     | 25          | A           |
| $I_{CM}$  | Collector Current – Pulse (Note1)                                                   | 75          | A           |
| $I_F$     | Diode Forward Current<br>- ( $T_C=25^{\circ}C$ )<br>- ( $T_C=100^{\circ}C$ )        | 25          | A           |
|           |                                                                                     | 12.5        | A           |
| $I_{FSM}$ | Surge non Repetitive Forward Current<br>$t_p=10ms$ Sinusoidal                       | 37.5        | A           |
| $V_{GE}$  | Gate-Emitter Voltage                                                                | $\pm 20$    | V           |
| $P_D$     | Power Dissipation( $T_C = 25^{\circ}C$ )                                            | 205         | W           |
| $T_j$     | Operating Junction Temperature                                                      | 150         | $^{\circ}C$ |
| $T_{stg}$ | Storage Temperature Range                                                           | -55 to +150 | $^{\circ}C$ |

\*Collector Current Limited by Maximum Junction Temperature.

### Thermal Characteristics

| Symbol          | Parameter                                      | Max  | Unit            |
|-----------------|------------------------------------------------|------|-----------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case for IGBT  | 0.61 | $^{\circ}C / W$ |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case for Diode | 1.55 | $^{\circ}C / W$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient        | 39   | $^{\circ}C / W$ |

|                                                                                  |                                                   |
|----------------------------------------------------------------------------------|---------------------------------------------------|
|  | <b>HBN25T120-SADCH</b>                            |
|                                                                                  | 1200V N-Channel Insulated Gate Bipolar Transistor |

### Electrical Characteristics(Tc=25°C unless otherwise noted)

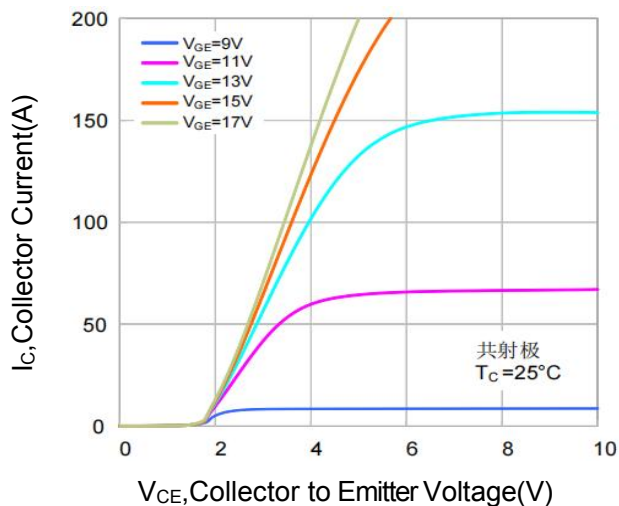
| Symbol                                                  | Parameter                               | Test Conditions                                                                                             | Min  | Typ  | Max  | Unit |
|---------------------------------------------------------|-----------------------------------------|-------------------------------------------------------------------------------------------------------------|------|------|------|------|
| Off Characteristics                                     |                                         |                                                                                                             |      |      |      |      |
| BV <sub>CES</sub>                                       | Collector-Emitter Breakdown Voltage     | V <sub>GE</sub> =0V ,I <sub>C</sub> =1mA                                                                    | 1200 | --   | --   | V    |
| I <sub>CES</sub>                                        | Zero Gate Voltage Collector Current     | V <sub>CE</sub> =1200V,V <sub>GE</sub> =0V                                                                  | --   | --   | 500  | μA   |
| I <sub>GESF</sub>                                       | Gate-Body Leakage Current,Forward       | V <sub>GE</sub> =+20V, V <sub>CE</sub> =0V                                                                  | --   | --   | 400  | nA   |
| I <sub>GESR</sub>                                       | Gate-Body Leakage Current,Reverse       | V <sub>GE</sub> =-20V, V <sub>CE</sub> =0V                                                                  | --   | --   | -400 | nA   |
| On Characteristics                                      |                                         |                                                                                                             |      |      |      |      |
| V <sub>GE(th)</sub>                                     | Gate Threshold Voltage                  | V <sub>CE</sub> = V <sub>GE</sub> , I <sub>C</sub> =1mA                                                     | 5.0  | 6.6  | 8.0  | V    |
| V <sub>CE(sat)</sub>                                    | Collector-Emitter Saturation Voltage    | V <sub>GE</sub> =15 V, I <sub>C</sub> =25A                                                                  | --   | 2.1  | 2.7  | V    |
| Dynamic Characteristics                                 |                                         |                                                                                                             |      |      |      |      |
| C <sub>ies</sub>                                        | Input Capacitance                       | V <sub>CE</sub> =30V,V <sub>GE</sub> =0V, f=1.0MHz                                                          | --   | 2770 | --   | pF   |
| C <sub>oes</sub>                                        | Output Capacitance                      |                                                                                                             | --   | 85   | --   | pF   |
| C <sub>res</sub>                                        | Reverse Transfer Capacitance            |                                                                                                             | --   | 19   | --   | pF   |
| Switching Characteristics                               |                                         |                                                                                                             |      |      |      |      |
| t <sub>d(on)</sub>                                      | Turn-On Delay Time                      | V <sub>CE</sub> = 600 V, I <sub>C</sub> = 25 A, R <sub>G</sub> = 10 Ω,V <sub>GE</sub> =15 V, Inductive Load | --   | 30   | --   | ns   |
| t <sub>r</sub>                                          | Turn-On Rise Time                       |                                                                                                             | --   | 78   | --   | ns   |
| t <sub>d(off)</sub>                                     | Turn-Off Delay Time                     |                                                                                                             | --   | 68   | --   | ns   |
| t <sub>f</sub>                                          | Turn-Off Fall Time                      |                                                                                                             | --   | 109  | --   | ns   |
| E <sub>on</sub>                                         | Turn-On Energy                          |                                                                                                             | --   | 2.3  | --   | mJ   |
| E <sub>off</sub>                                        | Turn-off Energy                         |                                                                                                             | --   | 0.42 | --   | mJ   |
| E <sub>ts</sub>                                         | Total Switching Energy                  |                                                                                                             | --   | 2.72 | --   | mJ   |
| Q <sub>g</sub>                                          | Total Gate Charge                       | V <sub>CE</sub> = 600 V, I <sub>C</sub> =25 A, V <sub>GE</sub> = 15 V                                       | --   | 92   | --   | nC   |
| Q <sub>ge</sub>                                         | Gate-Emitter Charge                     |                                                                                                             | --   | 31   | --   | nC   |
| Q <sub>gc</sub>                                         | Gate-Collector Charge                   |                                                                                                             | --   | 30   | --   | nC   |
| Anti-Parallel Diode Characteristics and Maximum Ratings |                                         |                                                                                                             |      |      |      |      |
| V <sub>F</sub>                                          | Collector-Emitter Diode Forward Voltage | I <sub>F</sub> =12.5A,T <sub>C</sub> =25°C                                                                  | --   | 2.1  | 2.8  | V    |
|                                                         |                                         | I <sub>F</sub> =12.5A,T <sub>C</sub> =125°C                                                                 | --   | 1.9  | --   | V    |
| t <sub>rr</sub>                                         | Diode Reverse Recovery Time             | I <sub>EC</sub> =10A                                                                                        | --   | 70   | --   | ns   |
| Q <sub>rr</sub>                                         | Diode Reverse Recovery Charge           | dI <sub>EC</sub> /dt=100A/μs                                                                                | --   | 121  | --   | nC   |

Notes:

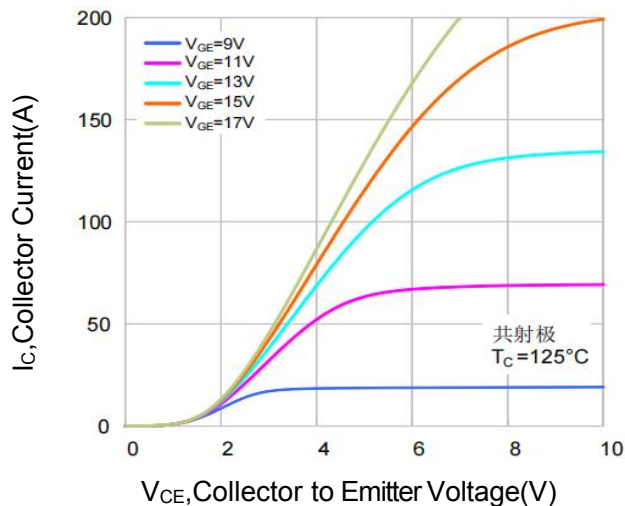
1、 Repetitive Rating:Pulse Width Limited by Maximum Junction Temperature.

### Typical Performance Characteristics

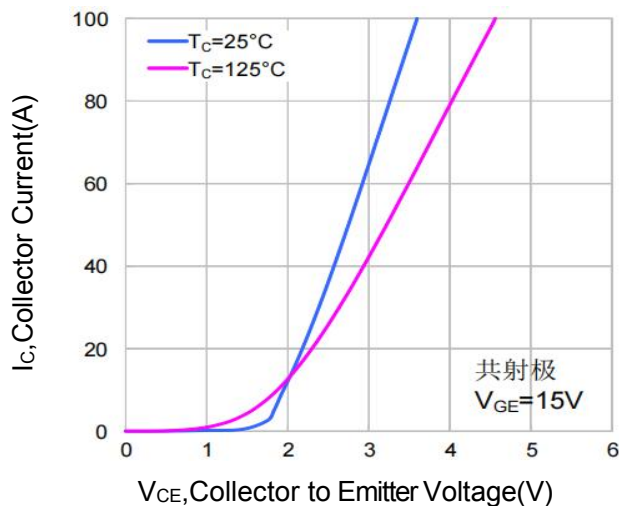
**Fig 1. Output Characteristic**



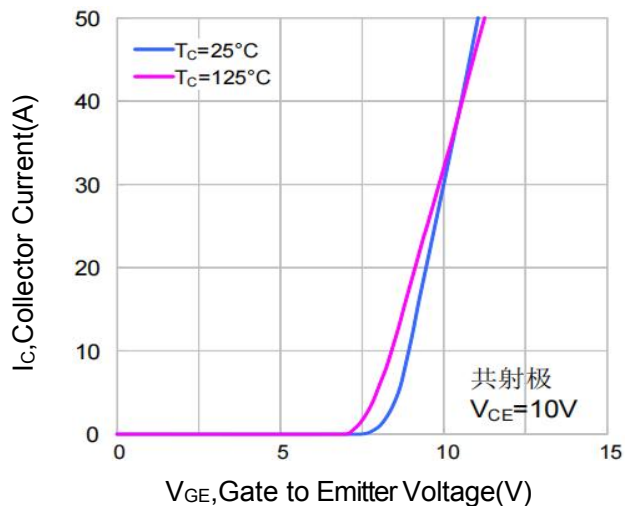
**Fig 2. Output Characteristic**



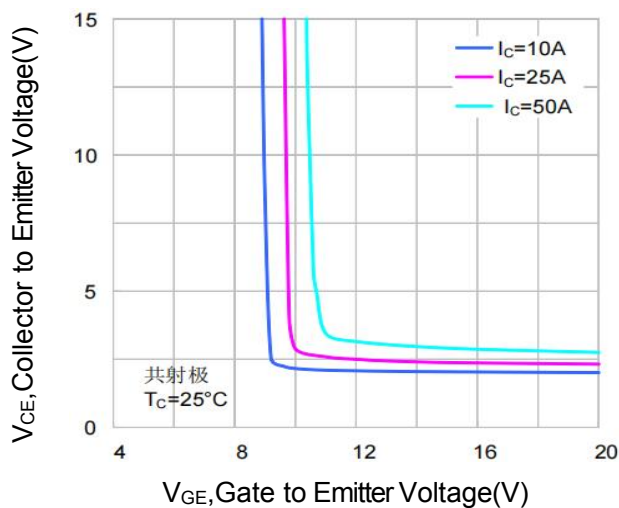
**Fig 3. Saturation Voltage Characteristic**



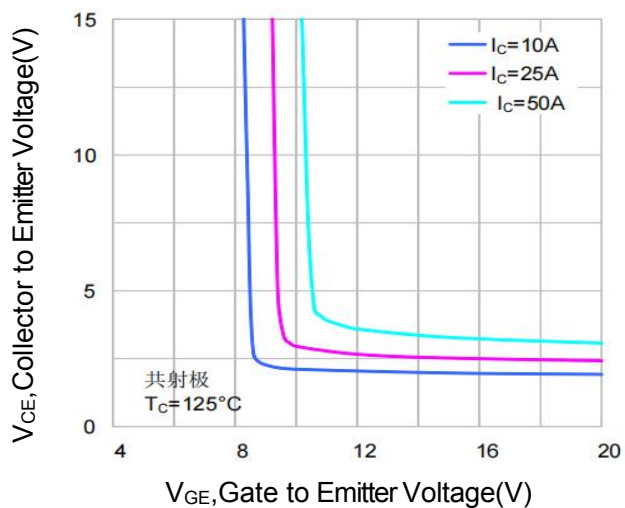
**Fig 4. Transfer Characteristic**



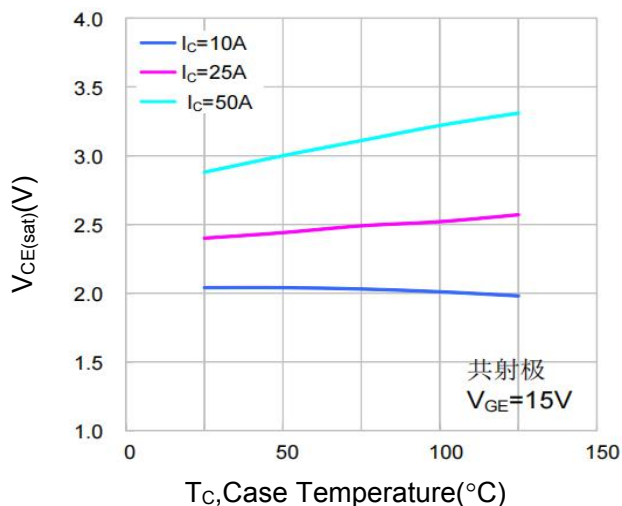
**Fig 5.  $V_{CE(sat)}$  vs.  $V_{GE}(V)$**



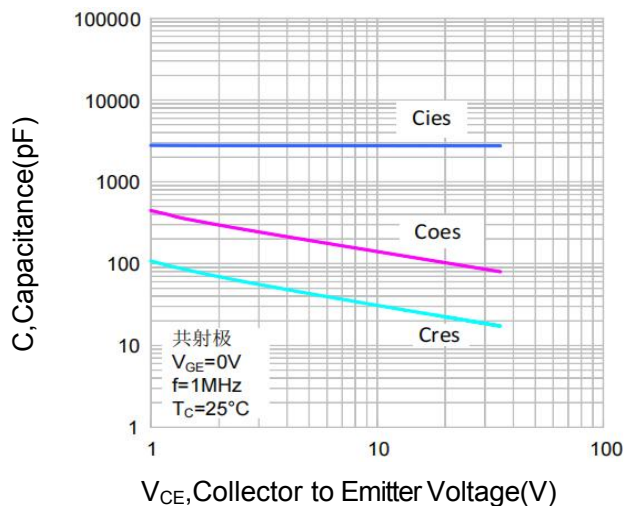
**Fig 6.  $V_{CE(sat)}$  vs.  $V_{GE}(V)$**



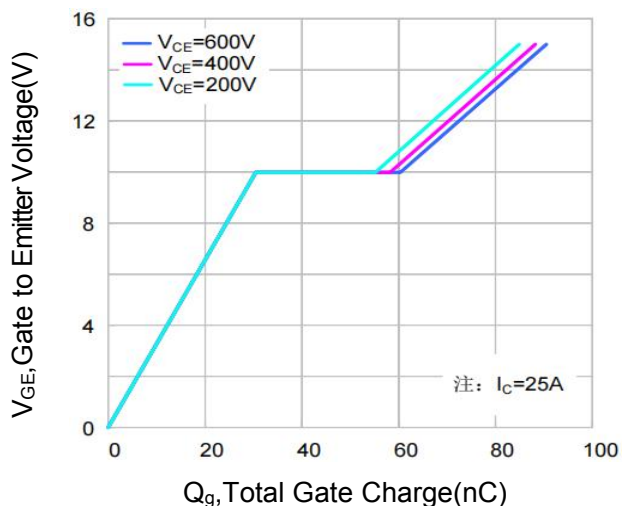
**Fig 7.  $V_{CE(sat)}$  vs.  $T_C$**



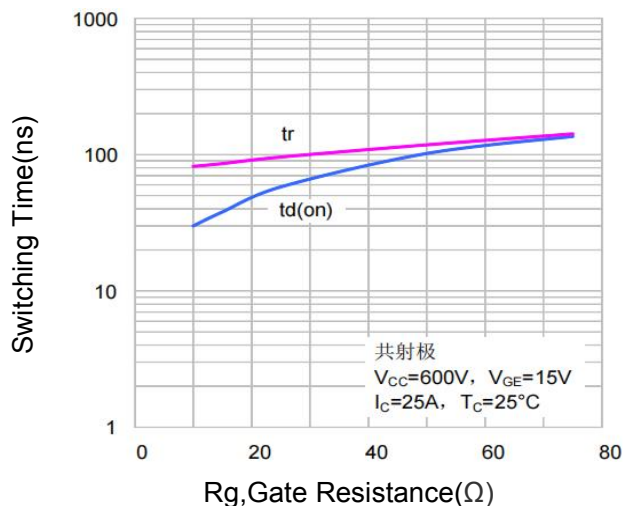
**Fig 8. Capacitance Characteristic**



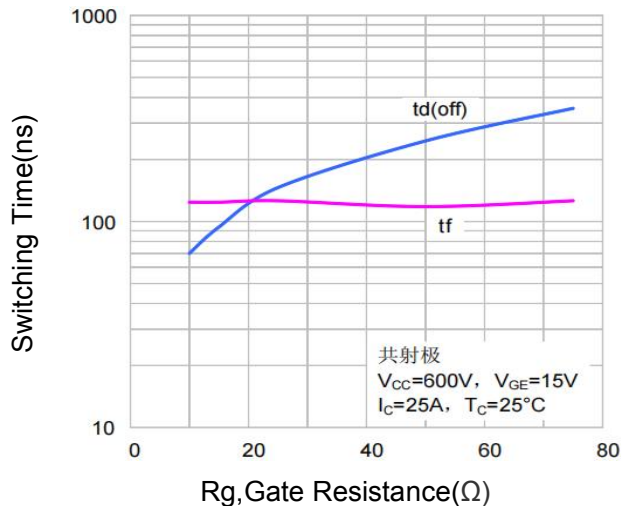
**Fig 9. Gate Charge Characteristics**



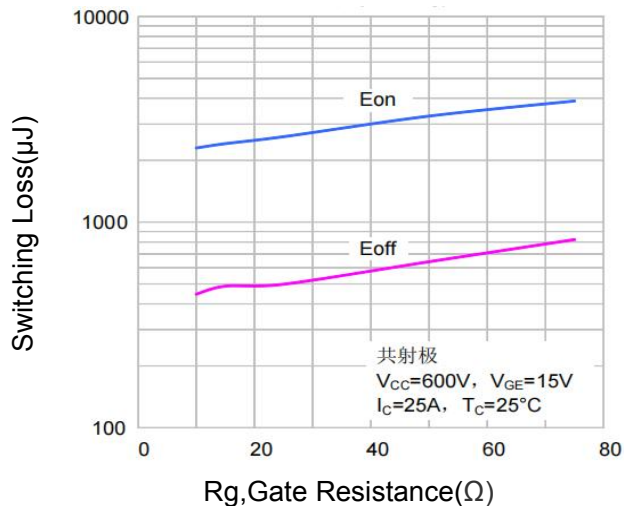
**Fig 10. Switching Time vs.  $R_g$**



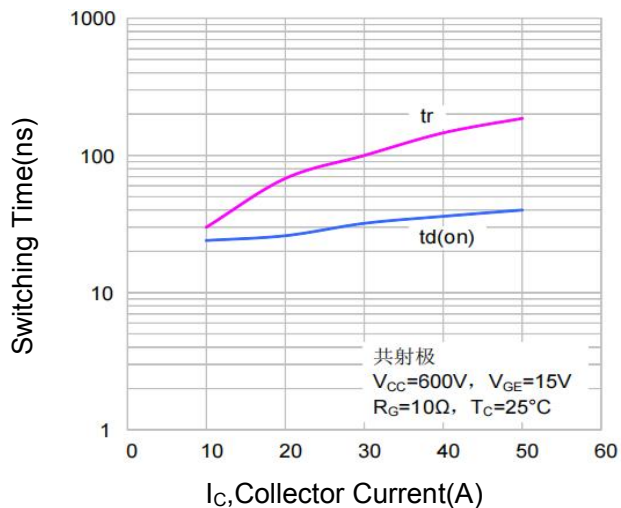
**Fig 11. Switching Time vs.  $R_g$**



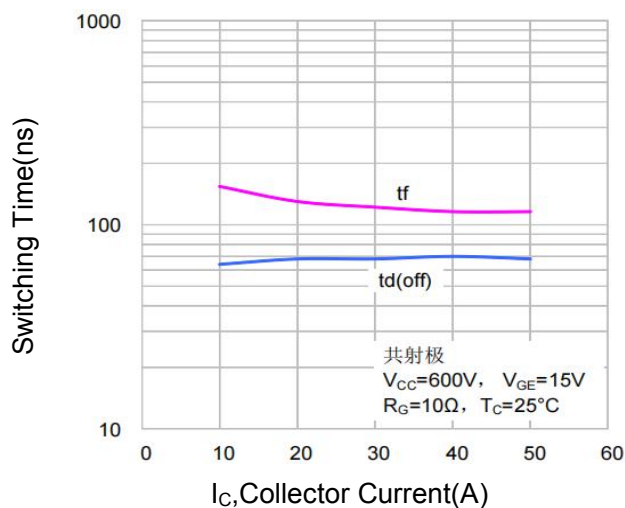
**Fig 12. Switching Loss vs.  $R_g$**



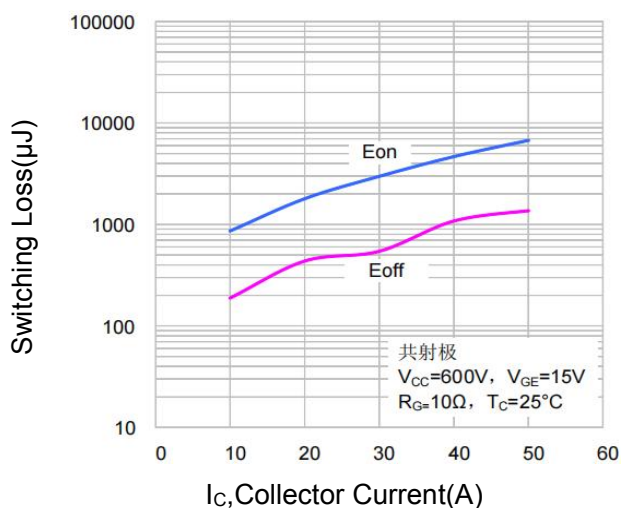
**Fig 13. Switching Time vs.  $I_c$**



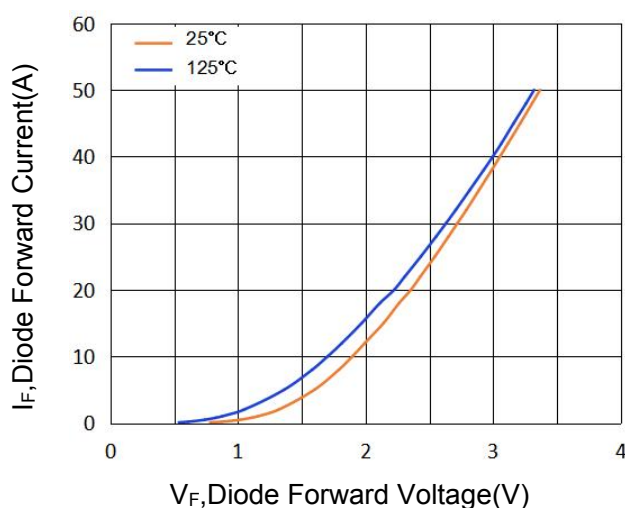
**Fig 14. Switching Time vs.  $I_c$**



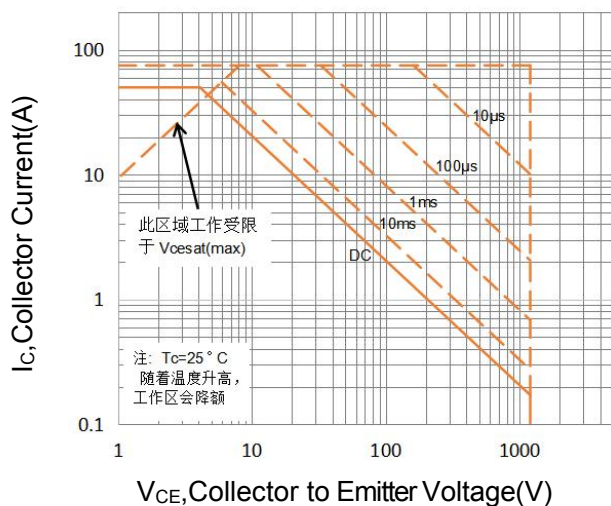
**Fig 15. Switching Loss vs.  $I_c$**



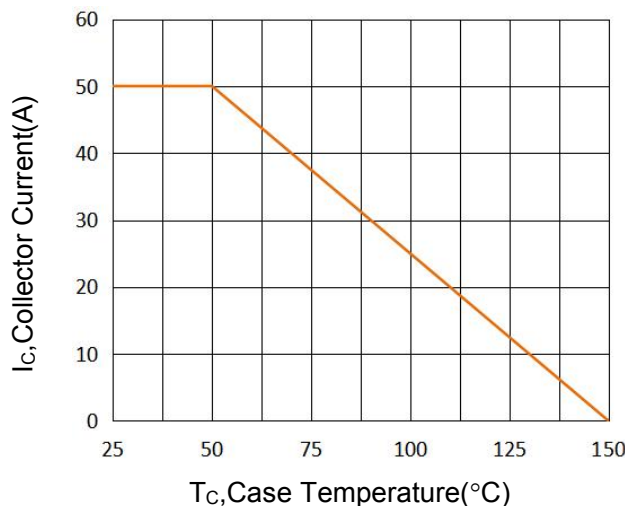
**Fig 16. Diode Forward Characteristic**



**Fig 17. Safe Operating Area**



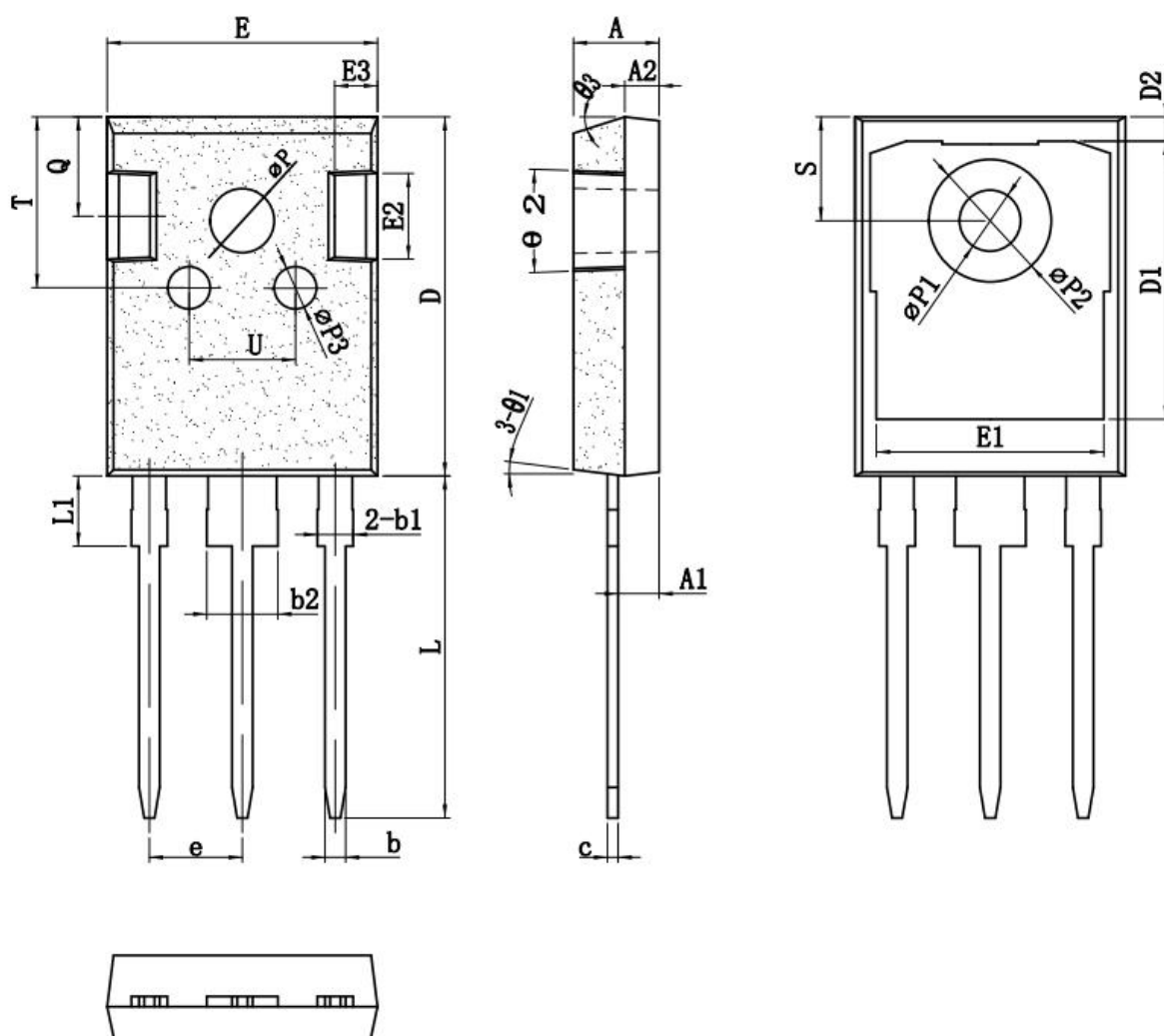
**Fig 18.  $I_c$  vs  $T_C$**



### TO-247-3L Package Dimensions

UNIT: mm

| SYMBOL | min   | nom   | max   | SYMBOL     | min   | nom   | max   |
|--------|-------|-------|-------|------------|-------|-------|-------|
| A      | 4.70  | 5.00  | 5.30  | e          | --    | 5.44  | --    |
| A1     | 2.20  | 2.40  | 2.60  | L          | 19.00 | 20.00 | 21.00 |
| A2     | 1.80  | 2.00  | 2.20  | L1         | 3.90  | 4.30  | 4.70  |
| b      | 1.00  | 1.20  | 1.40  | $\Phi P$   | 3.40  | 3.60  | 3.80  |
| b1     | 1.90  | 2.10  | 2.30  | $\Phi P1$  | 3.30  | 3.50  | 3.70  |
| b2     | 2.90  | 3.10  | 3.30  | $\Phi P2$  | 6.88  | 7.18  | 7.48  |
| c      | 0.50  | 0.60  | 0.70  | $\Phi P3$  | 2.20  | 2.50  | 2.80  |
| D      | 20.50 | 21.00 | 21.50 | Q          | 5.30  | 5.80  | 6.30  |
| D1     | 15.50 | 16.50 | 17.50 | S          | 5.65  | 6.15  | 6.65  |
| D2     | 0.90  | 1.20  | 1.50  | T          | 9.00  | 10.00 | 11.00 |
| E      | 15.30 | 15.80 | 16.30 | U          | 5.20  | 6.20  | 7.20  |
| E1     | 12.75 | 13.25 | 13.75 | $\theta 1$ | 5°    | 7°    | 9°    |
| E2     | 4.70  | 5.00  | 5.30  | $\theta 2$ | 1°    | 3°    | 5°    |
| E3     | 2.20  | 2.50  | 2.80  | $\theta 3$ | 13°   | 15°   | 17°   |



|                                                                                  |                                                   |
|----------------------------------------------------------------------------------|---------------------------------------------------|
|  | <b>HBN25T120-SADCH</b>                            |
|                                                                                  | 1200V N-Channel Insulated Gate Bipolar Transistor |

注意事项：

- 1、在电路设计时请不要超过器件的最大额定值，否则会影响整机的可靠性。
- 2、IGBT产品为静电敏感型器件，使用时应注意采取防静电保护措施，如佩戴防静电手环、设备接地等。
- 3、如需安装散热片，请注意控制扭力大小及散热片的平整度。
- 4、该规格书由华科公司制作，并可能不定期更改，恕不另行通知。
- 5、如有疑问，请及时联系我司销售代表。

版本履历表：

| 序号 | 版本号  | 修改时间       | 修改记录 |
|----|------|------------|------|
| 1  | V1.0 | 2023-11-20 | 首次发行 |
|    |      |            |      |